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| APPLICATION NO. FILING DATE | | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. | | |
|--|------------|----------------------|---------------------|-------------------------|-----------------|--|
| 10.063,869 | 05/21/2002 | | Chihiro Araki | SIMTEK6349 | 2434 | |
| 25776 | 7590 | 07 09 2003 | | | | |
| ERNEST A | | | EXAMINER | | | |
| ATTORNEY AT LAW 500 NEWPORT CENTER DRIVE | | | | NGUYEN, | NGUYEN, TRUNG Q | |
| SUITE 945 NEWPORT BEACH, CA 92660 | | | | ART UNIT | PAPER NUMBER | |
| | | | | 2829 | | |
| | | | | DATE MAILED: 07:09:2003 | | |

Please find below and/or attached an Office communication concerning this application or proceeding.

| | | \sim | | | | | |
|--|--|--|---|--|--|--|--|
| | Application No. | Applicant(s) | _ | | | | |
| | 10/063,869 | ARAKI, CHIHIRO | | | | | |
| Office Action Summary | Examiner | Art Unit | | | | | |
| | Trung Q Nguyen | 2829 | | | | | |
| The MAILING DATE of this communication a Period for Reply | appears on the cover sheet w | th the correspondence address | | | | | |
| A SHORTENED STATUTORY PERIOD FOR REF THE MAILING DATE OF THIS COMMUNICATION - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a real of the period for reply is specified above, the maximum statutory perion. - Failure to reply within the set or extended period for reply will, by stated and the period for reply will, by stated and the period period for reply will, by stated and the period period for reply will, by stated and patent term adjustment. See 37 CFR 1.704(b). - Status | N. 1.136(a). In no event, however, may a reply within the statutory minimum of thin od will apply and will expire SIX (6) MON tute, cause the application to become AB | eply be timely filed y (30) days will be considered timely. THS from the mailing date of this communication. BANDONED (35 U.S.C. § 133). | | | | | |
| 1)⊠ Responsive to communication(s) filed on 0 | <u>5 May 2003</u> . | | | | | | |
| <u> </u> | This action is non-final. | | | | | | |
| 3) Since this application is in condition for allo closed in accordance with the practice und | | | | | | | |
| Disposition of Claims | | | | | | | |
| 4) Claim(s) 1-3 and 6 is/are pending in the app | | | | | | | |
| 4a) Of the above claim(s) is/are withd | rawn from consideration. | | | | | | |
| 5) Claim(s) <u>4 and 5</u> is/are allowed. | | | | | | | |
| 6) Claim(s) is/are rejected. | | | | | | | |
| 7) Claim(s) is/are objected to. | dia alastian reguirement | | | | | | |
| 8) Claim(s) are subject to restriction and Application Papers | a/or election requirement. | | | | | | |
| 9) The specification is objected to by the Exami | iner. | | | | | | |
| 10) The drawing(s) filed on is/are: a) ac | | he Examiner. | | | | | |
| Applicant may not request that any objection to | | | | | | | |
| 11) The proposed drawing correction filed on | is: a) ☐ approved b) ☐ d | isapproved by the Examiner. | | | | | |
| If approved, corrected drawings are required in | reply to this Office action. | | | | | | |
| 12) The oath or declaration is objected to by the | Examiner. | | | | | | |
| Priority under 35 U.S.C. §§ 119 and 120 | | | | | | | |
| 13) Acknowledgment is made of a claim for fore | eign priority under 35 U.S.C. | § 119(a)-(d) or (f). | | | | | |
| a) ☐ All b) ☐ Some * c) ☐ None of: | | | | | | | |
| Certified copies of the priority docume | ents have been received. | | | | | | |
| 2. Certified copies of the priority docume | ents have been received in A | pplication No | | | | | |
| 3. Copies of the certified copies of the properties o | Bureau (PCT Rule 17.2(a)). | | | | | | |
| 14) Acknowledgment is made of a claim for dome | estic priority under 35 U.S.C. | § 119(e) (to a provisional application). | | | | | |
| a) ☐ The translation of the foreign language (15)☐ Acknowledgment is made of a claim for dome | | | | | | | |
| Attachment(s) | | | | | | | |
| Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449) Paper No(s) | 5) Notice of | Summary (PTO-413) Paper No(s) Informal Patent Application (PTO-152) | | | | | |
| S Patent and Trademark Office | | p | | | | | |

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-6 are rejected under 35 U.S.C. 102(b) as being anticipated by Spence et al. (U.S. 5,440,566).

As to claims 1-2, Spence et al. disclose in Figure 1 an inspection method for a semiconductor circuit with a plurality of connected semiconductor devices 11-18, comprising the steps of applying an electrical load 10 and 11a on the circuit 11, taking a photograph of the circuit via image processor 14 with a thermo-graphic camera 13 to detect heat development (column 3, lines 21-34) of each semiconductor device in response to the applied load 10, and determining via processing the quality and photograph through thermo-graphic camera 13 of the circuit and semiconductor devices based on the heat development (column 4, lines 48-65).

As to claim 2, Spence et al. disclose n Figure 1 at least some of the semiconductor devices are connected in parallel.

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As to claim 3, Spence et al. disclose in line 65 of column 5 to line 48 of column 6 temperature of the semiconductor devices are measured at different points (Xo, Yo), (Xn, Yn) of time, and the quality of the circuit and semiconductor device is determined based on the temperature difference.

As to claim 6, Spence et al. disclose in Figure 1 an inspection apparatus for a workpiece consisting of a semiconductor circuit with a plurality of connected semiconductors 11-18 comprising an apparatus body 11 on which a workpiece to be inspected is set, a loading circuit 11a for applying load corresponding to the condition of use to the workpiece 11, a power source 11d for supplying a working current to the workpiece through said loading circuit 11a, a drive waveform generating circuit via monitor and input 18 for applying drive signal to said workpiece, a thermo-graphic camera 13 for taking photographs of the workpiece set 10 on apparatus body 11, an image processor 14 connected to thermo-graphic camera 13 and a control 15 for controlling inspection apparatus to perform and inspection program.

Allowable Subject Matter

3. Claims 4-5 are allowed.

The following is a statement of reasons for the indication of allowable subject matter: claim 4 recites, inter alia, "an inspection method for a semiconductor circuit having the temperatures of the semiconductor devices are measured at different points of time at least twice to detect the heat development characteristic of each

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semiconductor device, this will advantage for any device whose solder joint has voids, has a more significant tendency of temperature rise in a temperature profile of upwardly convex shape when a drive signal is applied. Therefore, if temperatures are measured at different points of time more then twice, a general temperature profile can be obtained, and a device having a defective joint due to voids can be determined.

The art of record does not disclose the above limitations, nor would it be obvious to modify the art of record so as to include the above limitations.

Response to Arguments

- 4. Applicant's amendment with respect to claims 1-3 and have been considered but are most in view of the new ground(s) of rejection.
- 5. Applicant's amendment necessitated the new ground(s) of rejection presented in the Office Action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

Conclusion

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within two months of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened

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statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Trung Nguyen whose telephone number is 703-305-4925. The examiner can normally be reached on Monday through Friday, 8:30AM – 5:00PM. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-5841. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Cuneo Kammie can be reached at (703) 308-1233.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703)-308-0956.

Trung Nguyen

Patent Examiner Group Art Unit 2829 June 19, 2003